## **Product Summary**

V <sub>(BR)DSS</sub>	R <sub>DS(on)TYP</sub>	l <sub>D</sub>
150V	5.2mΩ@10V	185A



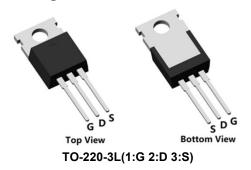
#### **Feature**

- Fast Switching
- Low Gate Charge and Rdson
- Advanced Split Gate Trench Technology
- 100% Single Pulse avalanche energy Test

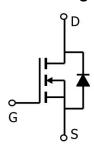
## **Applications**

- Power switching application
- DC-DC Converter
- Power Management

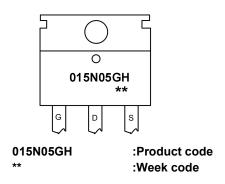
## **Package**



## Circuit diagram



## Marking



#### **Order Information**

Device	Package	Unit/Tube	
SP015N05GHTQ	TO-220-3L	50	



# Absolute maximum ratings (Ta=25°C,unless otherwise noted)

Parameter	Symbol	Rating	Unit
Drain-Source Voltage	V <sub>DS</sub>	150	V
Gate-Source Voltage	V <sub>GS</sub>	±20	V
Continuous Drain Current (Tc=25°ℂ)	I <sub>D</sub>	185	А
Continuous Drain Current (Tc=100℃)	I <sub>D</sub>	125	А
Pulsed Drain Current	I <sub>DM</sub>	740	А
Single Pulse Avalanche Energy <sup>1</sup>	Eas	1225	mJ
Power Dissipation (Tc=25°C)	P <sub>D</sub>	260	W
Thermal Resistance Junction-to-Case	Rejc	0.48	°C/W
Storage Temperature Range	T <sub>STG</sub>	-55 to 150	°C
Operating Junction Temperature Range	TJ	-55 to 150	$^{\circ}$

# Electrical characteristics (Ta=25°C, unless otherwise noted)

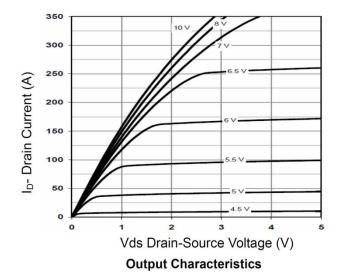
Characteristics	Symbol	Test Condition	Min	Тур	Max	Unit	
Static Characteristics							
Drain-Source Breakdown Voltage	BV <sub>DSS</sub>	ID = 250µA, VGS = 0V	150	-	-	V	
Drain Cut-Off Current	I <sub>DSS</sub>	VDS = 120V, VGS = 0V	-	-	1		
Gate Leakage Current	I <sub>GSS</sub>	VGS = ±20V, VDS = 0V	-	-	±0.1	μA	
Gate Threshold Voltage	$V_{GS(th)}$	VDS = VGS, ID = 250μA	2.0	3.0	4.0	V	
Drain-Source ON Resistance	R <sub>DS(ON)</sub>	VGS = 10V, ID = 20A	-	5.2	6.5	mΩ	
Dynamic Characteristics							
Input Capacitance	Ciss		-	5450	-		
Output Capacitance	Coss	VDS = 75V, VGS = 0V, f = 1.0MHz	-	690	-	pF	
Reverse Transfer Capacitance	C <sub>rss</sub>		-	26	-		
Total Gate Charge	Qg		-	78	-	nC	
Gate-Source Charge	Q <sub>gs</sub>	VDS=75V , VGS=10V , ID=104A	-	34	-		
Gate-Drain Charge	$Q_{gd}$		-	22	-		
Switching Characteristics							
Turn-On Delay Time	t <sub>d(on)</sub>		-	24	-		
Rise Time	t <sub>r</sub>	VGS = 10V, VDS = 50V, ID = 104A	-	35	-	20	
Turn-Off Delay Time	$t_{d(off)}$	RG = 6Ω	-	46	-	nS	
Fall Time	t <sub>f</sub>		-	15	-		
Drain-Source Body Diode Characteristics							
Source-Drain Diode Forward Voltage	V <sub>SD</sub>	I <sub>S</sub> = 1A, VGS = 0V	-	-	1.2	V	
Maximum Body-Diode Continuous Current	Is		-	-	185	Α	
Body Diode Reverse Recovery Time	Trr	I <sub>S</sub> =50A, di/dt=100A/us, TJ=25℃		108	-	nS	
Body Diode Reverse Recovery Charge	Qrr			312	-	nC	

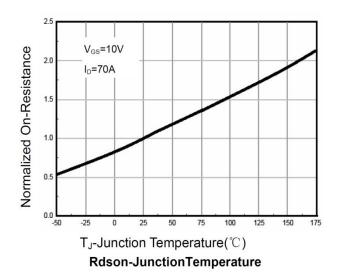
#### Note:

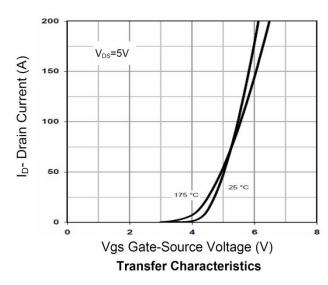
**1.** The test condition is VDD=50V,VGS=10V,L=0.5mH,RG=25 $\Omega$ ;

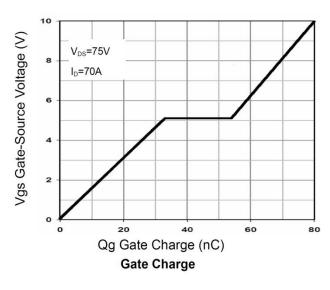
150V N-Channel Power MOSFET

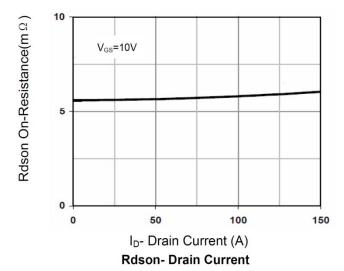
## **Typical Characteristics**

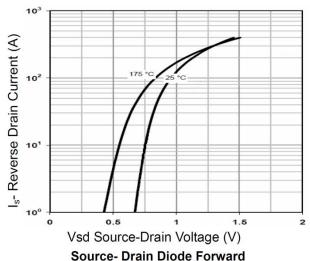




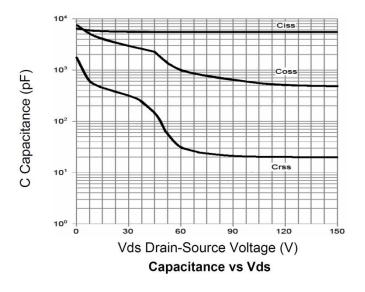


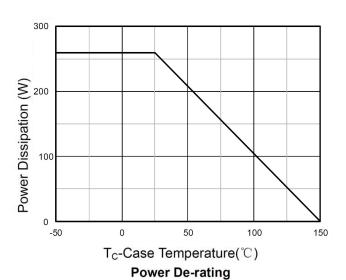


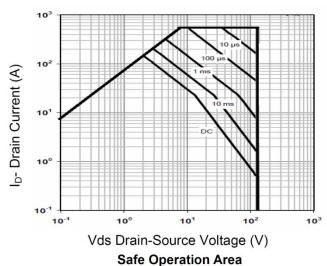


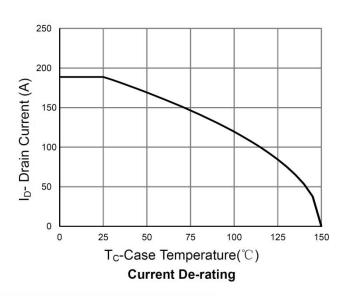


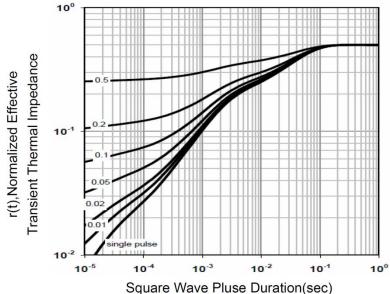






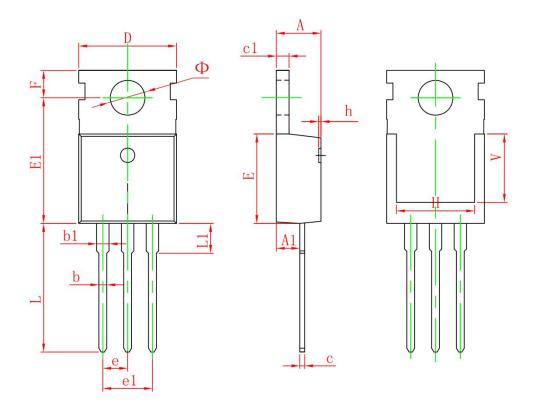






**Normalized Maximum Transient Thermal Impedance** 

# TO-220-3L Package Information



Symbol	Dimensions In Millimeters		Dimensions In Inches		
	Min.	Max.	Min.	Max.	
Α	4.400	4.600	0.173	0.181	
A1	2.250	2.550	0.089	0.100	
b	0.710	0.910	0.028	0.036	
b1	1.170	1.370	0.046	0.054	
С	0.330	0.650	0.013	0.026	
c1	1.200	1.400	0.047	0.055	
D	9.910	10.250	0.390	0.404	
E	8.950	9.750	0.352	0.384	
E1	12.650	13.050	0.498	0.514	
е	2.540 TYP.		0.100 TYP.		
e1	4.980	5.180	0.196	0.204	
F	2.650	2.950	0.104	0.116	
Н	7.900	8.100	0.311	0.319	
h	0.000	0.300	0.000	0.012	
L	12.900	13.400	0.508	0.528	
L1	2.850	3.250	0.112	0.128	
V	6.900 REF.		0.276 REF.		
Ф	3.400	3.800	0.134	0.150	